

# Integrated, Dual RF Transceiver with Observation Path

# Data Sheet **[AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf)**

## <span id="page-0-0"></span>**FEATURES**

**Dual differential Tx Dual differential Rx Observation receiver with 2 inputs Fully integrated, ultralow powerDPD actuator and adaptation engine for PA linearization Sniffer receiver with 3 inputs Tunable range: 300 MHz to 6000 MHz Linearization signal BW to 40 MHz Tx synthesis BW to 250 MHz Rx BW: 8 MHz to 100 MHz Supports FDD and TDD operation Fully integrated independent fractional-N RF synthesizers for Tx, Rx, ORx, and clock generation JESD204B digital interface**

## <span id="page-0-1"></span>**APPLICATIONS**

**3G/4G small cell base transceiver station (BTS) 3G/4G massive MIMO/active antenna systems**

## <span id="page-0-2"></span>**GENERAL DESCRIPTION**

Th[e AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) is a highly integrated, wideband radio frequency (RF) transceiver offering dual-channel transmitters (Tx) and receivers (Rx), integrated synthesizers, a fully integrated digital predistortion (DPD) actuator and adaptation engine, and digital signal processing functions. The IC delivers a versatile combination of high performance and low power consumption required by 3G/4G small cell and massive multiple input, multiple output (MIMO) equipment in both frequency division duplex (FDD) and time division duplex (TDD) applications. Th[e AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) operates from 300 MHz to 6000 MHz, covering most of the licensed and unlicensed cellular bands. The DPD algorithm supports linearization on signal bandwidths up to 40 MHz depending on the power amplifier (PA) characteristics (for example, two adjacent 20 MHz carriers). The IC supports Rx bandwidths up to 100 MHz. It also supports observation receiver (ORx) and Tx synthesis bandwidths up to 250 MHz to accommodate digital correction algorithms.

The transceiver consists of wideband direct conversion signal paths with state-of-the-art noise figure and linearity. Each complete Rx and Tx subsystem includes dc offset correction, quadrature error correction (QEC), and programmable digital filters, eliminating the need for these functions in the digital baseband. Several auxiliary functions such as an auxiliary analog-to-digital converter (ADC), auxiliary digital-to-analog converters (DACs), and generalpurpose input/outputs (GPIOs) are integrated to provide additional monitoring and control capability.

An ORx channel with two inputs is included to monitor each Tx output and implement calibration applications. This channel also connects to three sniffer receiver (SnRx) inputs that can monitor radio activity in different bands.

The high speed JESD204B interface supports lane rates up to 6144 Mbps. Four lanes are dedicated to the transmitters and four lanes are dedicated to the receiver and observation receiver channels.

The fully integrated phase-locked loops (PLLs) provide high performance, low power, fractional-N frequency synthesis for the Tx, the Rx, the ORx, and the clock sections. Careful design and layout techniques provide the isolation demanded in high performance base station applications. All voltage controlled oscillator (VCO) and loop filter components are integrated to minimize the external component count.

The device contains a fully integrated, low power DPD actuator and adaptation engine for use in PA linearization. The DPD feature enables use of high efficiency PAs, significantly reducing the power consumption of small cell base station radios while also reducing the number of JESD204B lanes necessary to interface with baseband processors.

A 1.3 V supply is required to power the [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) core, and a standard 4-wire serial port controls it. Other voltage supplies provide proper digital interface levels and optimize transmitter and auxiliary converter performance. Th[e AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) is packaged in a 12 mm × 12 mm, 196-ball chip scale ball grid array (CSP\_BGA).

### **Rev. 0 [Document Feedback](https://form.analog.com/Form_Pages/feedback/documentfeedback.aspx?doc=AD9375.pdf&product=AD9375&rev=0)**

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## <span id="page-1-0"></span>**REVISION HISTORY**

3/2017-Revision 0: Initial Version

## <span id="page-2-0"></span>FUNCTIONAL BLOCK DIAGRAM



Figure 1.

## <span id="page-3-0"></span>**SPECIFICATIONS**

Electrical characteristics at ambient temperature range, VDDA\_SER = 1.3 V, VDDA\_DES = 1.3 V, JESD\_VTT\_DES = 1.3 V, [VDDA\\_1P3](#page-9-2)<sup>1</sup> = 1.3 V, VDIG = 1.3 V, VDDA\_1P8 = 1.8 V, VDD\_IF = 2.5 V, and VDDA\_3P3 = 3.3 V; all RF specifications based on measurements that include printed circuit board (PCB) and matching circuit losses, unless otherwise noted.

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<sup>1</sup> VDDA\_1P3 refers to all analog 1.3 V supplies including the following: VDDA\_BB, VDDA\_CLKSYNTH, VDDA\_TXLO, VDDA\_RXRF, VDDA\_RXSYNTH, VDDA\_RXVCO,

VDDA\_RXTX, VDDA\_TXSYNTH, VDDA\_TXVCO, VDDA\_CALPLL, VDDA\_SNRXSYNTH, VDDA\_SNRXVCO, VDDA\_CLK, and VDDA\_RXLO.<br>- Synthesis BW) is the extended bandwidth used by digital correction algorithms to measure conditions and generate co

<sup>3</sup> Quadrature error correction (QEC) is the system for minimizing quadrature images of a desired signal.

4 Local oscillator leakage (LOL) is a measure of the amount of the LO signal that is passed from a mixer with the desired signal.

<sup>5</sup> Adjacent channel level reduction (ACLR) is a measure of the amount of power from the desired signal leaking into an adjacent channel.

<sup>6</sup> dBFS represents the ratio of the actual output signal to the maximum possible output level for a continuous wave output signal at the given RF attenuation setting. <sup>7</sup> Continuous wave (CW) is a single frequency signal.

<sup>8</sup> Note that the input signal power limit does not correspond to 0 dBFS at the digital output because of the nature of the continuous time Σ-∆ ADCs. Unlike the hard clipping characteristic of pipeline ADCs, these converters exhibit a soft overload behavior when the input approaches the maximum level.

 $^9$  Signal-to-noise ratio is limited by the baseband quantization noise.

## <span id="page-9-0"></span>**CURRENT AND POWER CONSUMPTION SPECIFICATIONS**

### **Table 2.**

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<sup>1</sup> VDDA\_1P3 refers to all analog 1.3 V supplies including the following: VDDA\_BB, VDDA\_CLKSYNTH, VDDA\_TXLO, VDDA\_RXRF, VDDA\_RXSYNTH, VDDA\_RXVCO, VDDA\_RXTX, VDDA\_TXSYNTH, VDDA\_TXVCO, VDDA\_CALPLL, VDDA\_SNRXSYNTH, VDDA\_SNRXVCO, VDDA\_CLK, and VDDA\_RXLO.

 $2$  QEC is the system for minimizing quadrature images of a desired signal.

<sup>3</sup> CW is a single frequency signal.

## <span id="page-11-0"></span>**TIMING SPECIFICATIONS**

## **Table 3.**



## <span id="page-12-0"></span>**Timing Diagrams**



<span id="page-12-1"></span>Figure 3. SYSREF\_IN Signal Setup and Hold Timing Examples Relative to DEV\_CLK\_IN Signal

## <span id="page-13-0"></span>ABSOLUTE MAXIMUM RATINGS

### **Table 4.**



<sup>1</sup> VDDA\_1P3 refers to all analog 1.3 V supplies: VDDA\_BB, VDDA\_CLKSYNTH, VDDA\_TXLO, VDDA\_RXSYNTH, VDDA\_RXVCO, VDDA\_RXTX, VDDA\_RXRF, VDDA\_TXSYNTH, VDDA\_TXVCO, VDDA\_CALPLL, VDDA\_SNRXSYNTH, VDDA\_SNRXVCO, VDDA\_CLK, and VDDA\_RXLO.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### <span id="page-13-1"></span>**REFLOW PROFILE**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) reflow profile is in accordance with the JEDEC JESD20 criteria for Pb-free devices. The maximum reflow temperature is 260°C.

### <span id="page-13-2"></span>**THERMAL RESISTANCE**

Thermal performance is directly linked to PCB design and operating environment. Careful attention to PCB thermal design is required.

 $\theta_{IA}$  is the natural convection junction-to-ambient thermal resistance measured in a one cubic foot sealed enclosure.  $\theta_{\text{IC}}$  is the junctionto-case thermal resistance.





<sup>1</sup> Power dissipation is 3.0 W for all test cases.

<sup>2</sup> Per JEDEC JESD51-7 for JEDEC JESD51-5 2S2P test board.

<sup>3</sup> Per JEDEC JESD51-2 (still air) or JEDEC JESD51-6 (moving air).

<sup>4</sup> Per MIL-STD 883, Method 1012.1.

<sup>5</sup> JEDEC entries refer to the JEDEC JESD51-9 (high-K thermal test board).

<sup>6</sup> N/A means not applicable.

### <span id="page-13-3"></span>**ESD CAUTION**



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

<span id="page-14-0"></span>

Figure 4. Pin Configuration

## <span id="page-14-1"></span>**Table 6. Pin Function Descriptions**





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<sup>1</sup> I is input, I/O is input/output, O is output, and N/A is not applicable.

## <span id="page-17-0"></span>TYPICAL PERFORMANCE CHARACTERISTICS

Temperature settings refer to the die temperature. The die temperature is 40°C for single-trace plots.

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Figure 5. Receiver Local Oscillator (LO) Leakage vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 6. Receiver Noise Figure vs. Receiver Attenuation, 700 MHz LO, 20 MHz Bandwidth, 30.72 MSPS Sample Rate, 20 MHz Integration Bandwidth (Includes 1 dB Matching Circuit Loss)



Figure 7. Receiver Noise Figure vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate, 20 MHz Integration Bandwidth (Includes 1 dB Matching Circuit Loss)



Figure 8. Receiver IIP2 vs.  $f_1$  Offset Frequency, 900 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 30.72 MSPS Sample Rate



Figure 9. Receiver IIP2 vs. Intermodulation Frequency, 900 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 10. Receiver IIP3 vs. f<sub>1</sub> Offset Frequency, 900 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth,  $f_2 = 2f_1 + 1$  MHz, 30.72 MSPS Sample Rate



Figure 11. Receiver IIP3 vs. Intermodulation Frequency, 900 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 12. Receiver Image vs. Receiver Attenuation, 800 MHz LO, Continuous Wave (CW) Signal 3 MHz Offset, 20 MHz RF Bandwidth, Background Tracking Calibration (BTC) Active, 30.72 MSPS Sample Rate



Figure 13. Receiver Gain vs. Receiver Attenuation, 800 MHz LO, CW Signal 3 MHz Offset, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 14. Receiver DC Offset vs. Receiver Attenuation, 800 MHz LO, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 15. Receiver HD2 vs. Receiver Attenuation, 800 MHz LO, CW Signal 3 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



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Figure 21. Transmitter Image vs. RF Attenuation, 20 MHz RF Bandwidth, 900MHz LO, Transmitter Quadrature Error Correction (QEC) Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW 10 MHz Offset from LO, 3 dB Digital Backoff, 122.88 MSPS Sample Rate



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Figure 30. Tx Adjacent Channel Leakage Ratio vs. RF Attenuation, 900 MHz LO, 20 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, Transmitter QEC and LO Leakage Tracking Active



Figure 31. Tx Alternate Channel Leakage Ratio vs. RF Attenuation, 900 MHz LO, 20 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, 2 dB Digital Backoff, Transmitter QEC and LO Leakage Tracking Active



Figure 32. LO Phase Noise vs. Offset Frequency, 3 dB Digital Backoff, 710 MHz LO







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122.88 MSPS Sample Rate, Test Equipment Noise Floor De-Embedded



Figure 36. Tx Output Power Spectrum, 2 dB Digital and 3 dB RF Backoff, 20 MHz RF Bandwidth, Transmitter QEC, and Internal LO Leakage Active, LTE 10 MHz Signal, 800 MHz LO, 1 MHz Resolution Bandwidth, 122.88 MSPS Sample Rate, Expanded Frequency View, Test Equipment Noise Floor De-Embedded



Figure 37. Transmitter EVM vs. RF Attenuation, 900 MHz LO, Transmitter LO Leakage and Transmitter QEC Tracking Active, 20 MHz RF Bandwidth, LTE 20 MHz Downlink Signal, 122.88 MSPS Sample Rate



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Figure 39. Transmitter HD3 vs. RF Attenuation, 800 MHz LO, 810 MHz CW Desired Signal, 20 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 40. Transmitter Output Power vs. RF Attenuation, 800 MHz LO, 810 MHz CW Desired Signal, 20 MHz RF Bandwidth, 122.88 MSPS Sample Rate



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Figure 42. Transmitter Frequency Response Deviation from Flatness vs. Frequency Offset from LO, 800 MHz LO, 20 MHz RF Bandwidth, 6 dB Digital Backoff, 122.88 MSPS Sample Rate



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Figure 50. Observation Receiver Gain vs. Observation Receiver Attenuation, 800 MHz LO, CW Signal 16 MHz Offset, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 51. Observation Receiver DC Offset vs. Observation Receiver Attenuation, 800 MHz LO, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



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Figure 53. Observation Receiver HD3 vs. Observation Receiver Attenuation, 800 MHz LO, CW Signal 16 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 54. Sniffer Receiver LO Leakage vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 55. Sniffer Receiver Noise Figure vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate, 20 MHz Integration Bandwidth



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Figure 57. Sniffer Receiver IIP3 vs. Intermodulation Frequency (f $_2$  – 2f $_1$ ), 600 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 58. Sniffer Receiver Image vs. Sniffer Receiver Attenuation, 600 MHz LO, CW Signal 3 MHz Offset, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



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Figure 61. Sniffer Receiver HD3 vs. Sniffer Receiver Attenuation, 600 MHz LO, CW Signal 3 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 62. Sniffer Receiver EVM vs. Sniffer Receiver Input Power, 600 MHz LO, 20 MHz RF Bandwidth, LTE 20 MHz Uplink Centered at DC, BTC Active, 30.72 MSPS Sample Rate



Figure 63. Sniffer Receiver Gain vs. Sniffer Receiver Attenuation, 600 MHz LO, CW Signal 3 MHz Offset, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate

## <span id="page-27-0"></span>**2.6 GHz BAND**



Figure 64. Receiver Local Oscillator (LO) Leakage vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate











Figure 67. Receiver IIP2 vs.  $f_1$  Offset Frequency, 2600 MHz LO, 0 dB Attenuation, 40 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 122.88 MSPS Sample Rate



Figure 68. Receiver IIP2 vs. Intermodulation Frequency, 2600 MHz LO, 0 dB Attenuation, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 69. Receiver IIP3 vs.  $f_1$  Offset Frequency, 2600 MHz LO, 0 dB Attenuation, 40 MHz RF Bandwidth,  $f_2 = 2 f_1 + 2 M$ Hz, 122.88 MSPS Sample Rate



Figure 70. Receiver IIP3 vs. Intermodulation Frequency, 2600 MHz LO, 0 dB Attenuation, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 71. Receiver Image vs. Receiver Attenuation, 2600 MHz LO, Continuous Wave (CW) Signal 5 MHz Offset, 40 MHz RF Bandwidth, Background Tracking Calibration (BTC) Active, 122.88 MSPS Sample Rate



Figure 72. Receiver Gain vs. Receiver Attenuation, 2600 MHz LO, CW Signal 5 MHz Offset, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 73. Receiver DC Offset vs. Receiver Attenuation, 2550 MHz LO, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 74. Receiver HD2 vs. Receiver Attenuation, 2600 MHz LO, CW Signal 5 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 40MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 75. Receiver HD3 vs. Receiver Attenuation, 2600 MHz LO, CW Signal 5 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 40 MHz RF Bandwidth, 122.88 MSPS Sample Rate



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Figure 77. Rx2 to Rx1 Crosstalk vs. Receiver LO Frequency, 40 MHz RF Bandwidth, CW Tone 3 MHz Offset from LO



Figure 78. Receiver Noise Figure vs. Close-In Interferer Signal Power, 2614 MHz LO, 2625 MHz CW Interferer, Noise Figure Integrated over 7 MHz to 10 MHz, 40 MHz RF Bandwidth



Figure 79. Receiver Noise Figure vs. Out-of-Band Interferer Signal Power, 2614 MHz LO, 2435 MHz CW Interferer, Noise Figure Integrated over 7 MHz to 10 MHz



Figure 80. Transmitter Image vs. RF Attenuation, 40 MHz RF Bandwidth, 2600 MHz LO, Transmitter Quadrature Error Correction (QEC) Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW 10MHz Offset from LO, 3 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 81. Transmitter Image vs. Desired Offset Frequency, 40 MHz RF Bandwidth, 2300 MHz LO, 0 dB RF Attenuation, Transmitter QEC Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW Signal, 3 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 82. Tx Output Power, Transmitter QEC, and External LO Leakage Active, 5 MHz CW Offset Signal, 1 MHz Resolution Bandwidth, 245.76 MSPS Sample Rate



Figure 83. Transmitter LO Leakage vs. RF Attenuation, 2300 MHz LO, External Transmitter QEC and LO Leakage Tracking Active, CW Signal 10 MHz Offset from LO, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth (If Input Power to the ORx Channel Is Not Held Constant, Device Performance Degrades as Shown in This Figure)



Figure 84. Transmitter LO Leakage vs. Offset Frequency, External Transmitter QEC and LO Leakage Tracking Active, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth



Figure 85. Tx1 to Rx1 Crosstalk vs. Receiver LO Frequency, 40 MHz Receiver RF Bandwidth, 40 MHz Transmitter RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 86. Tx2 to Rx2 Crosstalk vs. Receiver LO Frequency, 40 MHz Receiver RF Bandwidth, 40 MHz Transmitter RF Bandwidth, CWSignal 3 MHz Offset from LO



Figure 87. Tx2 to Tx1 Crosstalk vs. Transmitter LO Frequency, 40MHz RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 88. Transmitter Noise vs. RF Attenuation, 2600 MHz LO, 10 MHz Offset Frequency



Figure 89. Tx Adjacent Channel Leakage Ratio vs. RF Attenuation, 2600 MHz LO, 40 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, Transmitter QEC and LO Leakage Tracking Active



Figure 90. Tx Alternate Channel Leakage Ratio vs. RF Attenuation, 2600 MHz LO, 40 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, 2 dB Digital Backoff, Transmitter QEC and LO Leakage Tracking Active



Figure 91. LO Phase Noise vs. Offset Frequency, 3 dB Digital Backoff, 2600 MHz



Figure 92. Tx Integrated Phase Noise vs. Transmitter LO Frequency, 40 MHz RF Bandwidth, Continuous Wave 20 MHz Offset from LO, 3 dB Digital Backoff







Figure 94. Tx Output Power Spectrum, 2 dB Digital and 3 dB RF Backoff, 40 MHz RF Bandwidth, Transmitter QEC and Internal LO Leakage Active, LTE 10 MHz Signal, 2600 MHz LO, 1 MHz Resolution Bandwidth,

245.76 MSPS Sample Rate, Test Equipment Noise Floor De-Embedded



Figure 95. Tx Output Power Spectrum, 2 dB Digital and 3 dB RF Backoff, 40 MHz RF Bandwidth, Transmitter QEC and Internal LO Leakage Active, LTE 10 MHz Signal, 2600 MHz LO, 1 MHz Resolution Bandwidth, 245.76 MSPS Sample Rate, Expanded Frequency View, Test Equipment Noise Floor De-Embedded



Figure 96. Transmitter EVM vs. RF Attenuation, 2550 MHz LO, Transmitter LO Leakage and Transmitter QEC Tracking Active, 200 MHz RF Bandwidth, LTE 20 MHz Downlink Signal, 245.76 MSPS Sample Rate



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Figure 98. Transmitter HD3 vs. RF Attenuation, 2600 MHz LO, 2605 MHz CW Desired Signal, 40 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 99. Transmitter Output Power vs. RF Attenuation, 2600 MHz LO, 2605 MHz CW Desired Signal, 40 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 100. Tx Attenuation Step Error vs. RF Attenuation, 2600 MHz LO, 2610 MHz CW Desired Signal, 40 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 101. Transmitter Frequency Response Deviation from Flatness vs. Frequency Offset from LO, 2600 MHz LO, 100 MHz RF Bandwidth, 6 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 102. Observation Receiver LO Leakage vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 103. Observation Receiver Noise Figure vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate, 100 MHz Integration Bandwidth



Figure 104. Observation Receiver IIP2 vs.  $f_1$  Offset Frequency, 2600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 245.76 MSPS Sample Rate



Figure 105. Observation Receiver IIP2 vs. Intermodulation Frequency (f $_2$  – f $_1$ ), 2600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate







Figure 107. Observation Receiver IIP3 vs. Intermodulation Frequency (f $_2-2f_1$ ), 2600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 108. Observation Receiver Image vs. Observation Receiver Attenuation, 2600 MHz LO, CW Signal 25 MHz Offset, 200 MHz RF Bandwidth, BTC Active, 245.76 MSPS Sample Rate



Figure 109. Observation Receiver Gain vs. Observation Receiver Attenuation, 2600 MHz LO, CW Signal 25 MHz Offset, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 110. Observation Receiver DC Offset vs. Observation Receiver Attenuation, 2600 MHz LO, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 111. Observation Receiver HD2 vs. Observation Receiver Attenuation, 2600 MHz LO, CW Signal 25 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 112. Observation Receiver HD3 vs. Observation Receiver Attenuation, 2600 MHz LO, CW Signal 25 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 113. Sniffer Receiver LO Leakage vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 114. Sniffer Receiver Noise Figure vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate, 20 MHz Integration Bandwidth



Figure 115. Sniffer Receiver IIP2 vs. Intermodulation Frequency (f $_2 - f_1$ ), 2600MHz LO, 0dB Attenuation, 20 MHz RF Bandwidth, 30.72MSPS Sample Rate



Figure 116. Sniffer Receiver IIP3 vs. Intermodulation Frequency (f $_2$  – 2f<sub>1</sub>), 2600 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 117. Sniffer Receiver Image vs. Sniffer Receiver Attenuation, 2600 MHz LO, CW Signal 1 MHz Offset, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 118. Sniffer Receiver DC Offset vs. Sniffer Receiver Attenuation, 2600 MHz LO, CW Signal 1 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 119. Sniffer Receiver HD2 vs. Sniffer Receiver Attenuation, 2600 MHz LO, CW Signal 1 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 120. Sniffer Receiver HD3 vs. Sniffer Receiver Attenuation, 2600 MHz LO, CW Signal 1 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate



Figure 121. Sniffer Receiver EVM vs. Sniffer Receiver Input Power, 2600 MHz LO, 20 MHz RF Bandwidth, LTE 20 MHz Uplink Centered at DC, BTC Active, 30.72 MSPS Sample Rate



Figure 122. Sniffer Receiver Gain vs. Sniffer Receiver Attenuation, 2600 MHz LO, CW Signal 1 MHz Offset, 20 MHz RF Bandwidth, 30.72 MSPS Sample Rate

## <span id="page-37-0"></span>**3.5 GHz BAND**



Figure 123. Receiver Local Oscillator (LO) Leakage vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate







Figure 125. Receiver Noise Figure vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate, 50 MHz Integration Bandwidth (Includes 1 dB Matching Circuit Loss)



Figure 126. Receiver IIP2 vs.  $f_1$  Offset Frequency, 3500 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 153.6 MSPS Sample Rate



Figure 127. Receiver IIP2 vs. Intermodulation Frequency, 3500 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate



Figure 128. Receiver IIP3 vs.  $f_1$  Offset Frequency, 3500 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth,  $f_2 = 2 f_1 + 1$  MHz, 153.6 MSPS Sample Rate



Figure 129. Receiver IIP3 vs. Intermodulation Frequency, 3500 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate



Figure 130. Receiver Image vs. Receiver Attenuation, 3500 MHz LO, Continuous Wave (CW) Signal 17 MHz Offset, 100 MHz RF Bandwidth, Background Tracking Calibration (BTC) Active, 153.6 MSPS Sample Rate



Figure 131. Receiver Gain vs. Receiver Attenuation, 3500 MHz LO, CW Signal 17 MHz Offset, 100 MHz RF Bandwidth, De-Embedded to Receiver Port, 153.6 MSPS Sample Rate



Figure 132. Receiver DC Offset vs. Receiver Attenuation, 3500 MHz LO, 100MHz RF Bandwidth, 153.6 MSPS Sample Rate



Figure 133. Receiver HD2 vs. Receiver Attenuation, 3500 MHz LO, CWSignal 17MHz Offset, −14 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate



Figure 134. Receiver HD3 vs. Receiver Attenuation, 3500 MHz LO, CWSignal 17 MHz Offset, −14 dBm at 0 dB Attenuation, Input Power Increasing Decibel forDecibel with Attenuation, 100 MHz RF Bandwidth, 153.6 MSPS Sample Rate



Figure 135. Receiver Error Vector Magnitude (EVM) vs. Receiver Input Power, 3600 MHz LO, 100 MHz RF Bandwidth, LTE 20 MHz Uplink Centered at DC, BTC Active, 153.6 MSPS Sample Rate



Figure 136. Rx2 to Rx1 Crosstalk vs. Receiver LO Frequency, 100 MHz RF Bandwidth, CW Tone 3 MHz Offset from LO



Figure 137. Receiver Noise Figure vs. Close-In Interferer Signal Power, 3614 MHz LO, 3625 MHz CW Interferer, Noise Figure Integrated over 7 MHz to 10 MHz, 100 MHz RF Bandwidth



Figure 138. Receiver Noise Figure vs. Out of Band Interferer Signal Power, 3614 MHz LO, 3665 MHz CW Interferer, Noise Figure Integrated over 7 MHz to 10 MHz



Figure 139. Transmitter Image vs. RF Attenuation, 100 MHz RF Bandwidth, 3550 MHz LO, Transmitter Quadrature Error Correction (QEC) Tracking Run with Two 20 MHz, LTE Downlink Carriers, Then Image Measured with CW 10 MHz Offset from LO, 6 dB Digital Backoff, 307.2 MSPS Sample Rate



Figure 140. Transmitter Image vs. Desired Offset Frequency, 100 MHz RF Bandwidth, 3550 MHz LO, 0 dB RF Attenuation, Transmitter QEC Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW Signal, 6 dB Digital Backoff, 307.2 MSPS Sample Rate







Figure 142. Transmitter LO Leakage vs. RF Attenuation, 3550 MHz LO, Transmitter QEC and External LO Leakage Tracking Active, CW Signal 10 MHz Offset from LO, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth (If Input Power to ORx Channel Is Not Held Constant, Performance Degrades as Shown in This Plot)



Figure 143. Transmitter LO Leakage vs. Offset Frequency, Transmitter QEC and External LO Leakage Tracking Active, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth



Figure 144. Tx1 to Rx1 Crosstalk vs. Receiver LO Frequency, 100 MHz Receiver RF Bandwidth, 100 MHz Transmitter RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 145. Tx2 to Rx2 Crosstalk vs. Receiver LO Frequency, 100 MHz Receiver RF Bandwidth, 100 MHz Transmitter RF Bandwidth, CW Signal 3 MHz Offset from LO







Figure 147. Transmitter Noise vs. RF Attenuation, 3500 MHz LO, 100 MHz Offset Frequency, Zeros Input Data



Figure 148. Tx Adjacent Channel Leakage Ratio vs. RF Attenuation, 3500 MHz LO, 100 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, 2 dB Digital Backoff, Transmitter QEC and LO Leakage Tracking Active







Figure 150. LO Phase Noise vs. Offset Frequency, 3 dB Digital Backoff, 3500 MHz LO



Figure 151. Tx Integrated Phase Noise vs. Transmitter LO Frequency, 100 MHz RF Bandwidth, CW 20 MHz Offset from LO, 3 dB Digital Backoff



Figure 152. Transmitter OIP3 vs. RF Attenuation, 3500 MHz LO, 100 MHz RF Bandwidth,  $f_1 = 20$  MHz,  $f_2 = 21$  MHz, 3 dB Digital Backoff, 307.2 MSPS Sample Rate



Figure 153. Tx Output Power Spectrum, 2 dB Digital and 3 dB RF Backoff, 100 MHz RF Bandwidth, Transmitter QEC and Internal LO Leakage Active, LTE 10 MHz Signal, 3500 MHz LO, 1 MHz Resolution Bandwidth, 307.2 MSPS Sample Rate, Test Equipment Noise Floor De-Embedded



Figure 154. Tx Output Power Spectrum, 2 dB Digital and 3 dB RF Backoff, 100 MHz RF Bandwidth, Transmitter QEC and Internal LO Leakage Active, LTE 10 MHz Signal, 3500 MHz LO, 1 MHz Resolution Bandwidth, 307.2 MSPS Sample Rate, Expanded Frequency View, Test Equipment Noise Floor De-Embedded



Figure 155. Transmitter EVM vs. RF Attenuation, 3500 MHz LO, Transmitter LO Leakage, and Transmitter QEC Tracking Active, 100 MHz RF Bandwidth, LTE 20 MHz Downlink Signal, 307.2 MSPS Sample Rate



Figure 156. Transmitter HD2 vs. RF Attenuation, 3500 MHz LO, 3505 MHz CW Desired Signal, 100 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 157. Transmitter HD3 vs. RF Attenuation, 3500 MHz LO, 3505 MHz CW Desired Signal, 100 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 158. Transmitter Output Power vs. RF Attenuation, 3500 MHz LO, 3505 MHz CW Desired Signal, 100 MHz RF Bandwidth, 2 dB Digital Backoff, 307.2 MSPS Sample Rate



Figure 159. Tx Attenuation Step Error vs. RF Attenuation, 3500 MHz LO, 3510 MHz CW Desired Signal, 100 MHz RF Bandwidth, De-Embedded to Transmitter Port, 307.2 MSPS Sample Rate



Figure 160. Transmitter Frequency Response Deviation from Flatness vs. Frequency Offset from LO, 3500 MHz LO, 100 MHz RF Bandwidth, 6 dB Digital Backoff, 307.2 MSPS Sample Rate



Figure 161. Observation Receiver LO Leakage vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 162. Observation Receiver Noise Figure vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate, 120 MHz Integration Bandwidth



Figure 163. Observation Receiver IIP2 vs.  $f_1$  Offset Frequency, 3600 MHz LO, 0 dB Attenuation, 240 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 307.2 MSPS Sample Rate



Figure 164. Observation Receiver IIP2 vs. Intermodulation Frequency (f $_2$  – f $_1$ ), 3500 MHz LO, 0 dB Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 165. Observation Receiver IIP3 vs.  $f_1$  Offset Frequency, 3600 MHz LO, 0 dB Attenuation, 240 MHz RF Bandwidth,  $f_2 = 2f_1 + 1$  MHz, 307.2 MSPS Sample Rate



Figure 166. Observation Receiver IIP3 vs. Intermodulation Frequency (f $_2-2f_1$ ), 3500 MHz LO, 0 dB Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 167. Observation Receiver Image vs. Observation Receiver Attenuation, 3500 MHz LO, CW Signal 25 MHz Offset, 240 MHz RF Bandwidth, BTC Active, 307.2 MSPS Sample Rate



Figure 168. Observation Receiver Gain vs. Observation Receiver Attenuation, 3500 MHz LO, CW Signal 25 MHz Offset, 240 MHz RF Bandwidth, De-Embedded to Receiver Port, 307.2 MSPS Sample Rate



Figure 169. Observation Receiver DC Offset vs. Observation Receiver Attenuation, 3500 MHz LO, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 170. Observation Receiver HD2 vs. Observation Receiver Attenuation, 3500 MHz LO, CW Signal 25 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 171. Observation Receiver HD3 vs. Observation Receiver Attenuation, 3500 MHz LO, CW Signal 25 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 240 MHz RF Bandwidth, 307.2 MSPS Sample Rate



Figure 172. Sniffer Receiver LO Leakage vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 173. Sniffer Receiver Noise Figure vs. Sniffer Receiver LO Frequency, 0 dB Receiver Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate, 10 MHz Integration Bandwidth



Figure 174. Sniffer Receiver IIP2 vs. Intermodulation Frequency (f $_2 - f_1$ ), 3500MHz LO, 0dB Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 175. Sniffer Receiver IIP3 vs. Intermodulation Frequency (f $_2$  – 2f<sub>1</sub>), 3500 MHz LO, 0 dB Attenuation, 20 MHz RF Bandwidth, 38.4MSPS Sample Rate



Figure 176. Sniffer Receiver Image vs. Sniffer Receiver Attenuation, 3500MHz LO, CW Signal 5 MHz Offset, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 177. Sniffer Receiver DC Offset vs. Sniffer Receiver Attenuation, 3500 MHz LO, CW Signal 5 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 178. Sniffer Receiver HD2 vs. Sniffer Receiver Attenuation, 3500 MHz LO, CW Signal 5 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 179. Sniffer Receiver HD3 vs. Sniffer Receiver Attenuation, 3500 MHz LO, CW Signal 5 MHz Offset, −35 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 20 MHz RF Bandwidth, 38.4 MSPS Sample Rate



Figure 180. Sniffer Receiver EVM vs. Sniffer Receiver Input Power, 3600 MHz LO, 20 MHz RF Bandwidth, LTE 20 MHz Uplink Centered at DC, BTC Active, 38.4 MSPS Sample Rate



Figure 181. Sniffer Receiver Gain vs. Sniffer Receiver Attenuation, 3600 MHz LO, CW Signal 5 MHz Offset, 20 MHz RF Bandwidth, De-Embedded to Receiver Port, 38.4 MSPS Sample Rate

### <span id="page-47-0"></span>**5.5 GHz BAND**



Figure 182. Receiver Local Oscillator (LO) Leakage vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 183. Receiver Noise Figure vs. Receiver Attenuation, 5600 MHz LO, 100 MHz Bandwidth, 122.88 MSPS Sample Rate, 50 MHz Integration Bandwidth (Includes 1.2 dB Matching Circuit Loss)



Figure 184. Receiver Noise Figure vs. Receiver LO Frequency, 0 dB Receiver Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate, 50 MHz Integration Bandwidth (Includes 1.2 dB Matching Circuit Loss)



Figure 185. Receiver IIP2 vs.  $f_1$  Offset Frequency, 5600 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 122.88 MSPS Sample Rate



Figure 186. Receiver IIP2 vs. Intermodulation Frequency, 5600 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate







Figure 188. Receiver IIP3 vs. Intermodulation Frequency, 5600 MHz LO, 0 dB Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 189. Receiver Image vs. Receiver Attenuation, 5600 MHz LO, Continuous Wave (CW) Signal 10 MHz Offset, 100 MHz RF Bandwidth, Background Tracking Calibration (BTC) Active, 122.88 MSPS Sample Rate



Figure 190. Receiver Gain vs. Receiver Attenuation, 5600 MHz LO, CW Signal 10 MHz Offset, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 191. Receiver DC Offset vs. Receiver Attenuation, 5850 MHz LO, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 192. Receiver HD2 vs. Receiver Attenuation, 5600 MHz LO, CW Signal 10 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 193. Receiver HD3 vs. Receiver Attenuation, 5600 MHz LO, CW Signal 10 MHz Offset, −20 dBm at 0 dB Attenuation, Input Power Increasing Decibel for Decibel with Attenuation, 100 MHz RF Bandwidth, 122.88 MSPS Sample Rate



Figure 194. Receiver Error Vector Magnitude (EVM) vs. Receiver Input Power, 5600 MHz LO, 100 MHz RF Bandwidth LTE, 20 MHz Uplink Centered at DC, BTC Active, 122.88 MSPS Sample Rate







Figure 196. Receiver Noise Figure vs. Out-of-Band Interferer Signal Power, 5400 MHz LO, 5600 MHz CW Interferer, NF Integrated over 7 MHz to 10 MHz



Figure 197. Transmitter Image vs. RF Attenuation, 75 MHz RF Bandwidth, 5600 MHz LO, 0 dB RF Attenuation, Transmitter Quadrature Error Correction (QEC) Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW 10 MHz Offset from LO, 3 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 198. Transmitter Image vs. Desired Offset Frequency, 75 MHz RF Bandwidth, 5600 MHz LO, 0 dB RF Attenuation, Transmitter QEC Tracking Run with Two 20 MHz LTE Downlink Carriers, Then Image Measured with CW Signal, 3 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 199. Tx Output Power, Transmitter QEC, and External LO Leakage Active, 5 MHz CW Offset Signal, 1 MHz Resolution Bandwidth, 245.76 MSPS Sample Rate



Figure 200. Transmitter LO Leakage vs. RF Attenuation, 5600 MHz LO, External Transmitter QEC, and LO Leakage Tracking Active, CW Signal 10 MHz Offset from LO, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth



Figure 201. Transmitter LO Leakage vs. Offset Frequency, External Transmitter QEC and LO Leakage Tracking Active, 6 dB Digital Backoff, 1 MHz Measurement Bandwidth



Figure 202. Tx1 to Rx1 Crosstalk vs. Receiver LO Frequency, 100 MHz Receiver RF Bandwidth, 75 MHz Transmitter RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 203. Tx2 to Rx2 Crosstalk vs. Receiver LO Frequency, 100 MHz Receiver RF Bandwidth, 75 MHz Transmitter RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 204. Tx2 to Tx1 Crosstalk vs. Transmitter LO Frequency, 75 MHz RF Bandwidth, CW Signal 3 MHz Offset from LO



Figure 205. Transmitter Noise vs. RF Attenuation, 5600 MHz LO, 1 MHz Offset Frequency



Figure 206. Tx Adjacent Channel Leakage Ratio vs. RF Attenuation, 5600 MHz LO, 75 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, Transmitter QEC and LO Leakage Tracking Active



Figure 207. Tx Alternate Channel Leakage Ratio vs. RF Attenuation, 5600 MHz LO, 75 MHz RF Bandwidth, Four-Carrier W-CDMA Desired Signal, 2 dB Digital Backoff, Transmitter QEC and LO Leakage Tracking Active



Figure 208. LO Phase Noise vs. Offset Frequency, 3 dB Digital Backoff, 5850 MHz LO



Figure 209. Tx Integrated Phase Noise vs. Transmitter LO Frequency, 75 MHz RF Bandwidth, CW 10 MHz Offset from LO, 3 dB Digital Backoff



Figure 210. Transmitter OIP3 vs. RF Attenuation, 5600 MHz LO, 75 MHz RF Bandwidth,  $f_1 = 20$  MHz,  $f_2 = 21$  MHz, 3 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 211. Tx Output Power Spectrum, 3 dB Digital and 1 dB RF Backoff, 40 MHz RF Bandwidth, Transmitter QEC, and Internal LO Leakage Active, LTE 10 MHz Signal, 5850 MHz LO, 1 MHz Resolution Bandwidth, 122.88 MSPS Sample Rate, Test Equipment Noise Floor De-Embedded



Figure 212. Tx Output Power Spectrum, 3 dB Digital and 1 dB RF Backoff, 40 MHz RF Bandwidth, Transmitter QEC, and Internal LO Leakage Active, LTE 10 MHz Signal, 5850 MHz LO, 1 MHz Resolution Bandwidth, 122.88 MSPS Sample Rate, Expanded Frequency View, Test Equipment Noise Floor De-Embedded



Figure 213. Transmitter EVM vs. RF Attenuation, 5600 MHz LO, Transmitter LO Leakage, and Transmitter QEC Tracking Active, 75 MHz RF Bandwidth, LTE 20 MHz Downlink Signal, 245.76 MSPS Sample Rate



Figure 214. Transmitter HD2 vs. RF Attenuation, 5850 MHz LO, 5855 MHz CW Desired Signal, 75 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 215. Transmitter HD3 vs. RF Attenuation, 5850 MHz LO, 5855 MHz CW Desired Signal, 75 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 216. Transmitter Output Power vs. RF Attenuation, 5850 MHz LO, 5855 MHz CW Desired Signal, 75 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 217. Tx Attenuation Step Error vs. RF Attenuation, 5850 MHz LO, 5855MHz CW Desired Signal, 75 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 218. Transmitter Frequency Response Deviation from Flatness vs. Frequency Offset from LO, 5850 MHz LO, 200 MHz Synthesis Bandwidth, 6 dB Digital Backoff, 245.76 MSPS Sample Rate



Figure 219. Observation Receiver LO Leakage vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 220. Observation Receiver Noise Figure vs. Observation Receiver LO Frequency, 0 dB Receiver Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate, 100 MHz Integration Bandwidth



Figure 221. Observation Receiver IIP2 vs.  $f_1$  Offset Frequency, 5600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth,  $f_2 = f_1 + 1$  MHz, 245.76 MSPS Sample Rate



Figure 222. Observation Receiver IIP2 vs. Intermodulation Frequency ( $f_2 - f_1$ ), 5600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 223. Observation Receiver IIP3 vs.  $f_1$  Offset Frequency, 5600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth,  $f_2 = 2 f_1 + 1$  MHz, 245.76 MSPS Sample Rate



Figure 224. Observation Receiver IIP3 vs. Intermodulation Frequency (f $_2-2f_1$ ), 5600 MHz LO, 0 dB Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 225. Observation Receiver Image vs. Observation Receiver Attenuation, 5600 MHz LO, CW Signal 30 MHz Offset, 200 MHz RF Bandwidth, BTC Active, 245.76 MSPS Sample Rate



Figure 226. Observation Receiver Gain vs. Observation Receiver Attenuation, 5600 MHz LO, CW Signal 30 MHz Offset, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 227. Observation Receiver DC Offset vs. Observation Receiver Attenuation, 5850 MHz LO, CW Signal 30 MHz Offset, −15 dBm Input, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 228. Observation Receiver HD2 vs. Observation Receiver Attenuation, 5600 MHz LO, CW Signal 30 MHz Offset, −15 dBm Input, Input Power Increasing Decibel for Decibel with Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate



Figure 229. Observation Receiver HD3 vs. Observation Receiver Attenuation, 5600 MHz LO, CW Signal 30 MHz Offset, −15 dBm Input, Input Power Increasing Decibel for Decibel with Attenuation, 200 MHz RF Bandwidth, 245.76 MSPS Sample Rate

## <span id="page-55-0"></span>THEORY OF OPERATION

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) is a highly integrated RF transceiver that can be configured for a wide range of applications. The device integrates all the RF, mixed-signal, and digital blocks necessary to provide transmit and receive functions in a single device. Programmability allows the two receiver channels and two transmitter channels to be used in TDD and FDD systems for 3G and 4G cellular standards.

The observation receiver channel has two inputs for use in monitoring the transmitter outputs. This channel has a wide channel bandwidth that receives the entire transmit band and feeds it back to the digital section for error correction purposes. In addition, three sniffer receiver inputs can monitor different radio frequency bands (one at a time). These channels share the baseband ADC and digital processing with the two ORx inputs.

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains four high speed serial interface links for the transmit chain and four high speed serial interface links shared by the Rx, ORx, and SnRx channels (JESD204B, Subclass 1 compliant), providing a low pin count and reliable data interface to a field-programmable gate array (FPGA) or other custom integrated baseband solutions.

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) also provides self calibration for dc offset and quadrature error correction to maintain a high performance level under varying temperatures and input signal conditions. The device includes test modes that allow system designers to debug designs during prototyping and optimize radio configurations.

## <span id="page-55-1"></span>**TRANSMITTER (Tx)**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) employs a direct conversion transmitter architecture consisting of two identical and independently controlled channels that provide all the digital processing, mixed-signal, and RF blocks necessary to implement a direct conversion system. Both channels share a common frequency synthesizer.

The digital data from the JESD204B lanes pass through a fully programmable 96-tap FIR filter with optional interpolation. The FIR output is sent to a series of conversion filters that provide additional filtering and data rate interpolation prior to reaching the DAC. Each DAC has an adjustable sample rate and is linear up to full scale.

Once converted to baseband analog signals, the in-phase (I) and quadrature (Q) signals are filtered to remove sampling artifacts, and then the signals are fed to the upconversion mixers. At the mixer stage, the I and Q signals are recombined and modulated onto the carrier frequency for transmission to the output stage. Each transmit chain provides a wide attenuation adjustment range with fine granularity to help designers optimize SNR.

## <span id="page-55-2"></span>**RECEIVER (Rx)**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains dual receiver channels. Each Rx channel is a direct conversion system that contains a programmable attenuator stage, followed by matched I and Q mixers that downconvert received signals to baseband for digitization.

To achieve gain control, a programmed gain index map is implemented. This gain map distributes attenuation among the various Rx blocks for optimal performance at each power level. In addition, support is available for both automatic and manual gain control modes.

The receiver includes  $\Sigma$ - $\Delta$  ADCs and adjustable sample rates that produce data streams from the received signals. The signals can be conditioned further by a series of decimation filters and a fully programmable 72-tap FIR filter with additional decimation settings. The sample rate of each digital filter block is adjustable by changing the decimation factors to produce the desired output data rate.

## <span id="page-55-3"></span>**OBSERVATION RECEIVER (ORx)**

The ORx operates in a similar manner to the main receivers. Each input is differential and uses a dedicated mixer. The ORx inputs share a baseband ADC and baseband section; therefore, only one can be active at any time. The mixed signal and digital section is identical in design and operation to the main receiver channels. This channel can monitor the Tx channels and implement error correction functions. It can also be used as a general-purpose receiver.

## <span id="page-55-4"></span>**SNIFFER RECEIVER (SnRx)**

The sniffer receiver provides three differential inputs that can monitor different frequency bands. Each input has a low noise amplifier (LNA) that is multiplexed to feed a single mixer. The output of this mixer stage is multiplexed with the ORx receiver mixers to feed the same baseband section. The SnRx bandwidth is limited to 20 MHz. This receiver can also be used as a generalpurpose receiver if the bandwidth and RF performance are acceptable for a given application. The sniffer channel is also limited to operation from 300 MHz to 4000 MHz. Performance cannot be guaranteed for LO settings above 4000 MHz.

These receiver inputs also provide an LNA bypass mode that removes the gain of the LNA when large signals are present. Note that no requirements for the LNA bypass mode are included in [Table 1;](#page-3-1) performance specifications are only relative to the scenario in which the LNA is enabled.

## <span id="page-55-5"></span>**CLOCK INPUT**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) requires a differential clock connected to the DEV\_CLK\_IN+/DEV\_CLK\_IN− pins. The frequency of the clock input must be between 10 MHz and 320 MHz, and it must have very low phase noise because this signal generates the RF local oscillator and internal sampling clocks.

## <span id="page-56-0"></span>**SYNTHESIZERS**

## **RF PLL**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains three fractional-N PLLs to generate the RF LOs used by the transmitter, receiver, and observation receiver. The PLL incorporates an internal VCO and loop filter that require no external components. The internal VCO LDO regulators eliminate the need for additional external power supplies for the PLLs. These regulators only require an external bypass capacitor for each supply.

## **Clock PLL**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains a PLL synthesizer that generates all of the baseband related clock signals and SERDES clocks. This PLL is programmed based on the data rate and sample rate requirements of the system.

## <span id="page-56-1"></span>**SERIAL PERIPHERAL INTERFACE (SPI)**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) uses a SPI to communicate with the baseband processor (BBP). This interface can be configured as a 4-wire interface with dedicated receive and transmit ports, or it can be configured as a 3-wire interface with a bidirectional data communications port. This bus allows the BBP to set all device control parameters using a simple address data serial bus protocol.

Write commands follow a 24-bit format. The first bit sets the bus direction of the bus transfer. The next 15 bits set the address where data is written. The final eight bits are the data being transferred to the specific register address.

Read commands follow a similar format with the exception that the first 16 bits are transferred on the SDIO pin, and the final eight bits are read from th[e AD9375,](http://www.analog.com/AD9375?doc=AD9375.pdf) either on the SDO pin in 4-wire mode or on the SDIO pin in 3-wire mode.

## <span id="page-56-2"></span>**GPIO\_x AND GPIO\_3P3\_x PINS**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) general-purpose input/output signals referenced to the VDD\_IF supply can be configured for numerous functions. Some of these pins, when configured as outputs, are used by the BBP as real-time signals to provide a number of internal settings and measurements. This configuration allows the BBP to monitor receiver performance in different situations. A pointer register selects the information that is output to these pins. Signals used for manual gain mode, calibration flags, state machine states, and various receiver parameters are among the outputs that can be monitored on these pins. In addition, certain pins can be configured as inputs and used in various functions such as setting the receiver gain in real time.

The GPIO\_3P3\_x pins are referenced to the VDDA\_3P3 supply. These pins can provide control signals to other components such as voltage gain amplifiers (VGAs) or attenuators in the RF section that typically use a higher reference voltage.

## <span id="page-56-3"></span>**AUXILIARY CONVERTERS**

## **Auxiliary ADC Inputs (AUXADC\_x)**

Th[e AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains an auxiliary ADC that is multiplexed to four input pins (AUXADC\_0 through AUXADC\_3). This block can monitor system voltages without adding additional components. The auxiliary ADC is 12 bits with an input voltage range of 0.05 V to VDDA\_3P3 − 0.05 V. When enabled, the auxiliary ADC is free running. Software reads of the output value provide the last value latched at the ADC output.

## **Auxiliary DACs (AUXDAC\_x)**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) contains 10 identical auxiliary DACs (AUXDAC\_0 to AUXDAC\_9) that can supply bias voltages, analog control voltages, or other system functionality. The inputs of these auxiliary DACs (AUXDAC\_0 to AUXDAC\_9) are multiplexed with the GPIO\_ 3P3\_x pins according to [Table 7.](#page-56-4) The auxiliary DACs are 10 bits, have an output voltage range of approximately 0.5 V to 3.0 V, and have a current drive of 10 mA.

## <span id="page-56-4"></span>**Table 7. AUXDAC Input Pin Assignments**



## <span id="page-57-0"></span>**JESD204B DATA INTERFACE**

The digital data interface for the [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) uses JEDEC Standard JESD204B Subclass 1. The serial interface operates at speeds of up to 6144 Mbps. The benefits of the JESD204B interface include a reduction in required board area for data interface routing and smaller package options due to the need for fewer pins. Digital filtering is included in all receiver and transmitter paths to provide proper signal conditioning and sampling rates to meet the JESD204B data requirements. Examples of the digital filtering configurations for the Tx and Rx paths are shown in [Figure 230](#page-57-2) an[d Figure 231,](#page-57-3) respectively.

## <span id="page-57-1"></span>**POWER SUPPLY SEQUENCE**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) requires a specific power-up sequence to avoid undesired power-up currents. The optimal power-on sequence starts the process by powering up the VDIG and the VDDA\_1P3 (analog) supplies simultaneously. If they cannot power up simultaneously, the VDIG supply must power up first. The VDDA\_3P3, VDDA\_1P8, and JESD\_VTT\_DES supplies must then power up after the VDIG and VDDA\_1P3 supplies. Note that the VDD\_IF supply can power up at any time. It is also recommended to toggle the RESET signal after power has stabilized prior to configuration. Follow the reverse order of the power-up sequence to power down.

### **Table 8. Example Rx/Tx Interface Rates (Two Rx/Two Tx Channels, Maximum JESD204B Lane Rates)**



<span id="page-57-2"></span>

Figure 230. Example Tx Data Path Filter Implementation

<span id="page-57-3"></span>

Figure 231. Data Rx Data Path Filter Implementation

## <span id="page-58-0"></span>**DIGITAL PREDISTORTION (DPD)**

This device provides a fully integrated DPD function that linearizes the output of the power amplifier (PA) of the transmit system by altering the digital waveform to compensate for nonlinearities in the PA response. Both the DPD actuator and coefficient calculation engine are integrated. This functionality uses the ORx channel to monitor the output of the PA and calculates the appropriate predistortion to linearize the output. The integrated DPD capability allows the system to drive the PA closer to saturation, enabling a higher efficiency PA while maintaining linearity. The DPD is optimized for small cell PAs with rms output powers in the 250 mW to 10 W range and for a maximum occupied signal bandwidth of 40 MHz. The additional power consumed by the DPD block when enabled is less than 100 mW.

Performance enhancement is shown in [Figure 232](#page-58-1) for a 20 MHz LTE signal and in [Figure 233](#page-58-2) for a 40 MHz LTE output. In both cases, a Band 7 Skyworks SKY66297 high efficiency PA is used to demonstrate the adjacent channel level reduction (ACLR) improvement for a particular device. [Table 9 a](#page-58-3)n[d Table 10](#page-58-4) show the details of ACLR improvement that are achieved for these two scenarios when DPD is activated. Note that the magnitude of improvement in ACLR is heavily PA dependent and generally degrades as signal bandwidth increases.



<span id="page-58-1"></span>Figure 232. Output Spectrum for Normal Operation (Red) and with DPD Activated (Blue) for a 20 MHz LTE Signal



<span id="page-58-2"></span>Figure 233. Output Spectrum for Normal Operation (Red) and with DPD Activated (Blue) for a 40 MHz LTE Output

### **Mode<sup>1</sup> 20 MHz Offset (dBc) 40 MHz Offset (dBc) 60 MHz Offset (dBc) Lower Upper Lower Upper Lower Upper** Normal Operation  $-32.15$   $-34.18$   $-51.71$   $-51.16$   $-59.29$   $-58.99$ DPD Activated −50.89 −51.90 −52.63 −56.57 −57.23 −59.49

### <span id="page-58-3"></span>**Table 9. ACLR Comparison With and Without DPD for a 20 MHz LTE Waveform**

<sup>1</sup> Waveform is 10 ms (full-frame) LTE evolved universal terrestrial radio access (E-UTRA) Test Model 1.1 (E-TM 1.1) at 7.5 dB peak to average ratio (PAR), with crest factor reduction (CFR), 28 dBm output, and 18.02 MHz occupied bandwidth.

### <span id="page-58-4"></span>**Table 10. ACLR Comparison With and Without DPD for a 40 MHz LTE Waveform**



<sup>1</sup> Waveform is 10 ms (full frame) LTE E-UTRA Test Model 1.1 (E-TM 1.1) at 7.5 dB PAR (with CFR), 27 dBm output, and 36.04 MHz occupied bandwidth.

## <span id="page-59-0"></span>**JTAG BOUNDARY SCAN**

The [AD9375](http://www.analog.com/AD9375?doc=AD9375.pdf) provides support for a JTAG boundary scan. Five dual-function pins are associated with the JTAG interface. These pins, listed i[n Table 11,](#page-59-1) are used to access the on-chip test access port. To enable the JTAG functionality, set the GPIO\_0 through GPIO\_3 pins according t[o Table 12](#page-59-2) depending on how the desired JESD204B sync pin (that is, SYNCINB0+, SYNCINB0−, SYNCINB1+, SYNCINB1−, SYNCOUTB0+, or SYNCOUTB0−) is configured in the software (LVDS or CMOS mode). Pull the TEST pin high to enable the JTAG mode.

### <span id="page-59-2"></span>**Table 12. JTAG Modes**



1 X means don't care.

<span id="page-59-1"></span>



## <span id="page-60-0"></span>OUTLINE DIMENSIONS



Dimensions shown in millimeters

### <span id="page-60-1"></span>**ORDERING GUIDE**



 $1 Z =$  RoHS-Compliant Part.

<sup>2</sup> See th[e Thermal Resistance](#page-13-2) section.



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